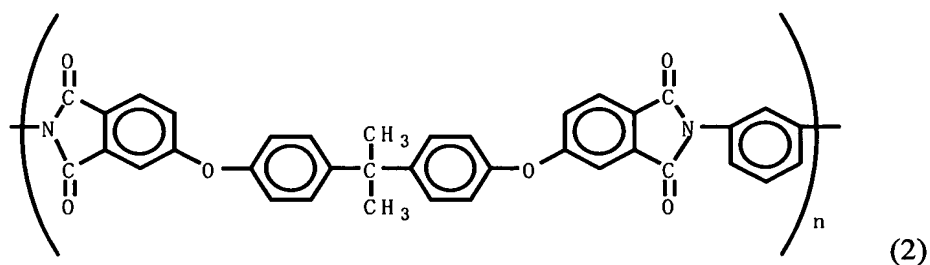
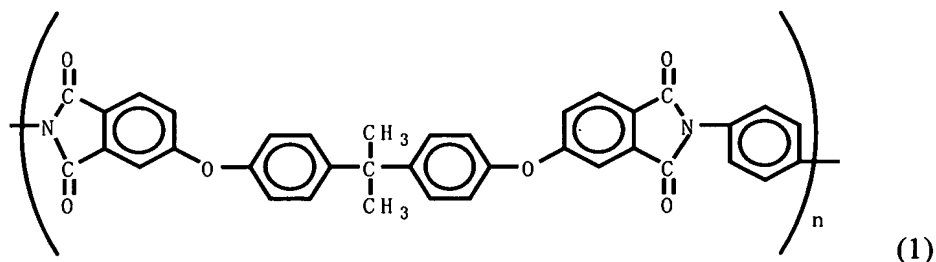


Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Original) A film comprising (A-1) a polyetherimide resin having repeating units of the following structural formula (1), (A-2) a polyetherimide resin having repeating units of the structural formula (2), (B) a polyarylketone resin having a melting peak temperature of 260 degrees C or higher, and a filler in an amount of from 5 to 50 parts by weight, based on total 100 parts by weight of (A-1), (A-2) and (B), wherein a weight ratio of the resin components, $[(A-1) + (A-2)] / (B)$, ranges from 70/30 to 30/70 and a weight ratio, (A-1) / (A-2), ranges from 70/30 to 30/70.



2. (Original) The film according to claim 1, wherein the amount of the filler ranges from 10 to 45 parts by weight, based on total 100 parts by weight of (A-1), (A-2) and (B), and

the weight ratio, $[(A-1) + (A-2)]/(B)$, ranges from 65/35 to 35/65 and the weight ratio, $(A-1)/(A-2)$, ranges from 65/35 to 35/65.

3. (Original) The film according to claim 1, wherein the amount of the filler ranges from 20 to 40 parts by weight, based on total 100 parts by weight of (A-1), (A-2) and (B), and the weight ratio, $[(A-1) + (A-2)]/(B)$, ranges from 65/35 to 45/55 and the weight ratio, $(A-1)/(A-2)$, ranges from 65/35 to 50/50.

4. (Currently Amended) A metal laminate comprising the film according to claim 1 ~~any one of claims 1 to 3~~ and a metal body laminated on at least one side of said film.

5. (Original) The metal laminate according to claim 4, wherein the metal body comprises copper, aluminum, or stainless steel.

6. (Currently Amended) A multilayered board comprising at least two copper laminated films, each comprising the film according to claim 1 ~~any one of claims 1 to 3~~ and a copper foil laminated on one side of said film.

7. (Original) A resin composition comprising (A-1) a polyetherimide resin having repeating units of the structural formula (1), (A-2) a polyetherimide resin having repeating units of the structural formula (2), (B) a polyaryleketone resin having a melting peak temperature of 260 degrees C or higher, and a filler in an amount of from 5 to 50 parts by weight, based on total 100 parts by weight of (A-1), (A-2) and (B), wherein a weight ratio of the resin components, $[(A-1) + (A-2)]/(B)$, ranges from 70/30 to 30/70 and a weight ratio, $(A-1)/(A-2)$, ranges from 70/30 to 30/70.

8. (New) A metal laminate comprising the film according to claim 2 and a metal body laminated on at least one side of said film.

9. (New) A metal laminate comprising the film according to claim 3 and a metal body laminated on at least one side of said film.

10. (New) A multilayered board comprising at least two copper laminated films, each comprising the film according to claim 2 and a copper foil laminated on one side of said film.

11. (New) A multilayered board comprising at least two copper laminated films, each comprising the film according to claim 3 and a copper foil laminated on one side of said film.